

2N5861 (SILICON)

NPN SILICON ANNULAR MEMORY DRIVER

... designed for medium-current, high-speed switching applications. Ideally suited for ferrite core memory driver circuits.

- High Collector-Emitter Breakdown Voltage --
BVCEO = 50 Vdc (Min) @ IC = 10 mAdc
- Low Collector-Emitter Saturation Voltage --
VCE(sat) = 0.5 Vdc (Max) @ IC = 500 mAdc
- Low Collector-Base Capacitance --
Ccb = 7.0 pF (Max) @ VCB = 10 Vdc
- Fast Switching Times @ IC = 500 mAdc --
ton = 25 ns (Max)
toff = 60 ns (Max)

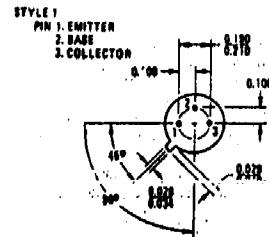
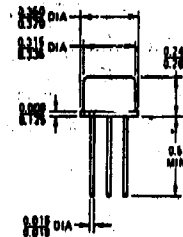
**NPN SILICON
MEMORY DRIVER
TRANSISTOR**



***MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	VCEO	50	Vdc
Collector-Base Voltage	VCB	100	Vdc
Emitter-Base Voltage	VEB	6.0	Vdc
Collector Current - Continuous	IC	2.0	A dc
Total Device Dissipation @ TA = 25°C Derate above 25°C	PD	1.0 6.0	Watts mW/°C
Total Device Dissipation @ TC = 25°C Derate above 25°C	PD	5.0 28.6	Watts mW/°C
Operating and Storage Junction Temperature Range	TJ, Tstg	-65 to +200	°C

*Indicates JEDEC Registered Data



To convert inches to millimeters multiply by 25.4
All JEDEC dimensions and notes apply

CASE
TO-30



ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage (I _C = 10 mA, I _B = 0)	BV _{CEO}	50	—	V _{dc}	
Collector-Base Breakdown Voltage (I _C = 100 μA, I _E = 0)	BV _{CBO}	100	—	V _{dc}	
Emitter-Base Breakdown Voltage (I _E = 10 μA, I _C = 0)	BV _{EBO}	6.0	—	V _{dc}	
Collector Cutoff Current (V _{CE} = 50 Vdc, V _{BE(off)} = 2.0 Vdc) (V _{CE} = 50 Vdc, V _{BE(off)} = 2.0 Vdc, T _A = 75°C)	I _{CEX}	—	0.3 10	μA _{dc}	
Collector Cutoff Current (V _{CB} = 50 Vdc, I _E = 0) (V _{CB} = 50 Vdc, I _E = 0, T _A = +75°C)	I _{CBO}	—	0.3 10	μA _{dc}	
Emitter Cutoff Current (V _{BE} = 5.0 Vdc, I _C = 0)	I _{EBO}	—	0.1	μA _{dc}	
ON CHARACTERISTICS					
DC Current Gain (I _C = 500 mA, V _{CE} = 1.0 Vdc) (I _C = 500 mA, V _{CE} = 1.0 Vdc, T _A = -55°C)	h _{FE}	25 10	100 —	—	
Collector-Emitter Saturation Voltage (I _C = 500 mA, I _B = 50 mA)	V _{CE(sat)}	—	0.6	V _{dc}	
Base-Emitter Saturation Voltage (I _C = 500 mA, I _B = 50 mA)	V _{BE(sat)}	0.8	1.1	V _{dc}	
DYNAMIC CHARACTERISTICS					
Current-Gain-Bandwidth Product (I _C = 50 mA, V _{CE} = 10 Vdc, f = 100 MHz)	f _T	200	—	MHz	
Collector-Base Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 100 kHz)	C _{cb}	—	7.0	pF	
Emitter-Base Capacitance (V _{BE} = 0.5 Vdc, I _C = 0, f = 100 kHz)	C _{eb}	—	60	pF	
SWITCHING CHARACTERISTICS					
Turn-On Time	(V _{CC} = 30 Vdc, V _{BE(off)} = 2.0 Vdc, I _C = 500 mA, I _{B1} = 50 mA) (Figure 1)	t _{on}	—	25	ns
Delay Time		t _d	—	8.0	ns
Rise Time		t _r	—	18	ns
Turn-Off Time	(V _{CC} = 30 Vdc, I _C = 500 mA, I _{B1} = I _{B2} = 50 mA) (Figure 2)	t _{off}	—	60	ns
Storage Time		t _s	—	35	ns
Fall Time		t _f	—	35	ns